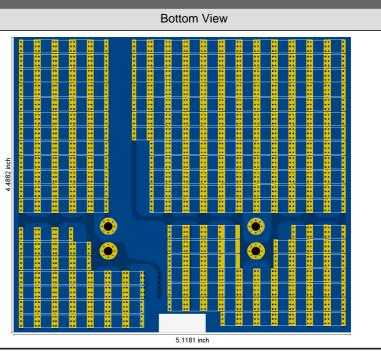


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Name	o7lr4oxz.zip	ld.	34389 - QED OK
Report Generated on	May 7, 2019 4:57:22 PM	Customer	InstantDFM
Board Id			

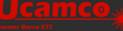


Summary - General - Original	
PCB Size	5.1181 inch x 4.4882 inch
PCB Thickness	62.00 mil
Customer Panel Size	
Copper Layers	2
Solder Mask	Both
Solder Mask Color	Blue
Legend	Both
Legend Color	White
Peeloff Mask	None
Carbon Mask	None
Edge Connectors	No

Surface Finish	unknown
Max. Aspect Ratio on PTH	3.1
Number of Nets	10
Electrical Test	Double Sided
Drilled SMD Pads	Yes
SMD Pads Top	604
SMD Pads Bottom	596
BGA Pads Top	0
BGA Pads Bottom	0
Drill Hole Density	80 Holes/inch <sup>2</sup>

Summary - (	Copper Laye	rs - Original									
Layer Type	Min. Copper Width	Min. Critical Copper Width	Min. Trace Width	Min. Critical Trace Width	Min. Clr. Copper to Copper	Min. Clr. Trace to Trace	Min. Same Net Spacing	Min. Ring	Copper to Plated Clr.		Copper to Outline Clr.
	mil	mil	mil	mil	mil	mil	mil	mil	mil	mil	mil
Outer	>16.00	>16.00	>16.00	>16.00	23.62	>20.00	>20.00	6.50	>32.00		23.94

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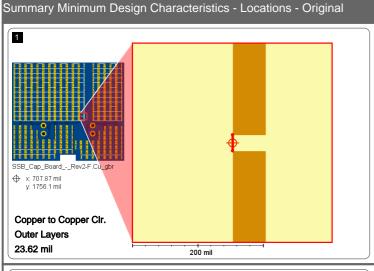


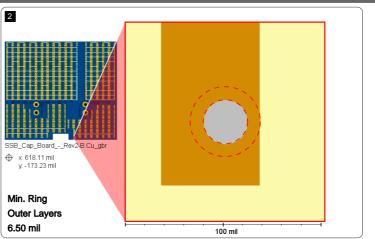


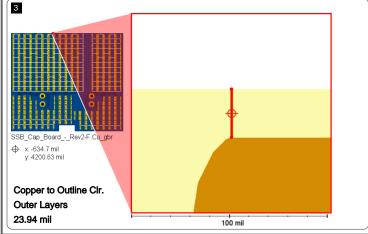
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Summary - Sequen	Summary - Sequences - Original													
Туре	Sequences Tools		Min. End Dia.			Moves	Min. Ring on Outer	Min. Ring on Inner	Min. Clr. Hole to Copper					
			mil	mil			mil	mil	mil					
Blind	0													
Buried	0													
PTH	1	3	19.70	126.00	1818	0	6.50		>32.00					
Plated (Total)	1	3	19.70	126.00	1818	0	6.50		>32.00					
NPTH	0													
Total	1	3	19.70	126.00	1818	0	6.50		>32.00					







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Stackup - Original		
		Cap_BoardRev2-F.Cu_gbr Cap_BoardRev2-B.Cu_gbr
Pressing Stages 1		

Copper Layer Minima & Area - Original														
File	Pos.	Min. Copper Width	Min. Critical Copper Width	Min. Trace Width	Min. Critical Trace Width	Min. Clr. Copper to Copper	Min. Clr. Trace to Trace	Min. Same Net Spacing	Min. Ring	Copper to Plated Clr.	Copper to NPTH Clr.	Copper to Outline Clr.	Copper A	rea
		mil	mil	mil	mil	mil	mil	mil	mil	mil	mil	mil	inch <sup>2</sup>	%
SSB_Cap_Board_ Rev2-F.Cu_gbr	1	>16.00	>16.00	>16.00	>16.00	23.62	>20.00	>20.00	10.98	>32.00		23.94	8.3408	37
SSB_Cap_Board_ Rev2-B.Cu_gbr	2	>16.00	>16.00	>16.00	>16.00	>32.00	>20.00	>20.00	6.50	>32.00		23.94	8.5539	38

Drill Tools - Original																
File	Tool Nr.	Span	Type	Method	FilledVia	Countere d	Dia.	Tol. Min	Tol. Plus	Holes (in PCB)	Moves (in PCB)	Doubl e Hits (in File)	Predril I Hits (in File)	Min. Ring on Outer	Min. Ring on Inner	Min. Pad Size
							mil	mil	mil					mil	mil	mil
SSB_Cap_Boar dRev2_drl	1	1-2	PTH	unknow n	unknown	unknown	19.70	0.00	0.00	32	0	0	0	21.65		63.00
SSB_Cap_Boar dRev2_drl	2	1-2	PTH	unknow n	unknown	unknown	22.00	0.00	0.00	1782	0	8	0	6.50		35.00
SSB_Cap_Boar dRev2_drl	3	1-2	PTH	unknow n	unknown	unknown	126.0 0	0.00	0.00	4	0	0	0	>32.0 0		> 190.0 0

Sequences	- Original									
Span	Туре	Tools	Min. End Dia.	Max. End Dia.	Holes	Min. Ring on Outer	Min. Ring on Inner	Min. Clr. Hole to Copper	Min. Clr. Hole to Outline	Min. Clr. Slot to Outline
			mil	mil		mil	mil	mil	mil	mil
1-2	PTH	3	19.70	126.00	1818	6.50		>32.00	63.80	disabled
All	Plated	3	19.70	126.00	1818	6.50		>32.00	63.80	disabled
All	All	3	19.70	126.00	1818	6.50		>32.00	63.80	disabled

Rout Tools - Original						
File	Tool Nr.	Туре	Tool Dia.	End Dia.	Draw Length	Nibble Count
			mil	mil	mil	

Routed Holes - Original						
File	Hole Nr.	Instances	X Size	Y Size	Draw Length	Nibble Count
			mil	mil	mil	

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Solder Mask - Original								
Side	Min. Ring on Cu Defined Pads	Min. Ring on SM Defined Pads	Min. Clr. Mask to Mask	Min. Web	Min. Clr. Mask to Copper	Fully Covered Via Holes	Partly Covered Via Holes	TH Via Holes Half Mask
	mil	mil	mil	mil	mil			
Тор	7.30	>10.00	>10.00	7.48	>10.00	No	No	
Bottom	7.30	>10.00	>10.00	3.30	>10.00	Yes	Yes	
Both	7.30	>10.00	>10.00	3.30	>10.00	Yes	Yes	Yes

Files - Original							
Initial	Renamed	Format	Function	Position	Color		
SSB_Cap_BoardRev2-F.SilkS.gbr	SSB_Cap_BoardRev2-F.SilkS_gbr	ger274x	silk	top	white		
SSB_Cap_BoardRev2-F.Mask.gbr	SSB_Cap_BoardRev2-F.Mask_gbr	ger274x	mask	top	blue		
SSB_Cap_BoardRev2-F.Cu.gbr	SSB_Cap_BoardRev2-F.Cu_gbr	ger274x	outer	1			
SSB_Cap_BoardRev2-B.Cu.gbr	SSB_Cap_BoardRev2-B.Cu_gbr	ger274x	outer	2			
SSB_Cap_BoardRev2-B.Mask.gbr	SSB_Cap_BoardRev2-B.Mask_gbr	ger274x	mask	bottom	blue		
SSB_Cap_BoardRev2-B.SilkS.gbr	SSB_Cap_BoardRev2-B.SilkS_gbr	ger274x	silk	bottom	white		
SSB_Cap_BoardRev2.drl	SSB_Cap_BoardRev2_drl	excellon2	plated	1-2			
SSB_Cap_BoardRev2-Edge.Cuts.gbr	SSB_Cap_BoardRev2-Edge.Cuts_gbr	ger274x	cad_outline	none			

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